

Design verification as per IEC/EN 61439

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| Technical data for design verification | | | |
| Heat dissipation, at an ambient temperature of 35°C, delta T: 20 degrees, calculated as per IEC 60890 | | | |
| Individual enclosure for wall mounting | P _V | CO | 61 |
| Starting enclosure for wall mounting | P _V | CO | 59 |
| Middle enclosure for wall mounting | P _V | CO | 56 |
| Heat dissipation, at an ambient temperature of 35°C, delta T: 35 degrees, calculated as per IEC 60890 | | | |
| Individual enclosure for wall mounting | P _V | CO | 123 |
| Starting enclosure for wall mounting | P _V | CO | 118 |
| Middle enclosure for wall mounting | P _V | CO | 113 |
| IEC/EN 61439 design verification | | | |
| 10.2 Strength of materials and parts | | | |
| 10.2.2 Corrosion resistance | | | Meets the product standard's requirements. |
| 10.2.3.1 Verification of thermal stability of enclosures | | | Meets the product standard's requirements. |
| 10.2.3.2 Verification of resistance of insulating materials to normal heat | | | Meets the product standard's requirements. |
| 10.2.3.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects | | | Meets the product standard's requirements. |
| 10.2.4 Resistance to ultra-violet (UV) radiation | | | Not relevant to indoor installations. |
| 10.2.5 Lifting | | | Does not apply to enclosures without lifting aids. |
| 10.2.6 Mechanical impact | | | IK08 |
| 10.2.7 Inscriptions | | | Meets the product standard's requirements. |
| 10.3 Degree of protection of ASSEMBLIES | | | IP30 |
| 10.4 Clearances and creepage distances | | | Is the panel builder's responsibility. |
| 10.5 Protection against electric shock | | | < 0.1 Ω; meets the product standard's requirements. |
| 10.6 Incorporation of switching devices and components | | | Is the panel builder's responsibility. |
| 10.7 Internal electrical circuits and connections | | | Is the panel builder's responsibility. |
| 10.8 Connections for external conductors | | | Is the panel builder's responsibility. |
| 10.9 Insulation properties | | | |
| 10.9.2 Power-frequency electric strength | | | U _i = 400 V AC |
| 10.9.3 Impulse withstand voltage | | | 2.5 kV |
| 10.9.4 Testing of enclosures made of insulating material | | | Does not apply to metal enclosures. |
| 10.10 Temperature rise | | | The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices. |
| 10.11 Short-circuit rating | | | Is the panel builder's responsibility. |
| 10.12 Electromagnetic compatibility | | | Is the panel builder's responsibility. |
| 10.13 Mechanical function | | | Meets the product standard's requirements. |